



# 6N65

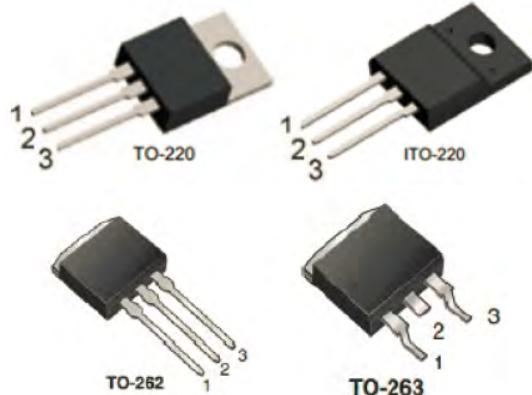
## 650V N-Channel Power MOSFET

### Features

- $R_{DS(on)} < 1.7\Omega$  @  $V_{GS} = 10V$
- Fast switching capability
- Lead free in compliance with EU RoHS directive.
- Green molding compound

### PRODUCT SUMMARY

$V_{DS}$ (V)	Current (A)	$R_{DS(on)}$ ( $\Omega$ )
650	6	1.7 @ $V_{GS} = 10V$



Pin Definition:

1. Gate
2. Drain
3. Source

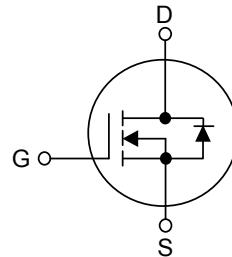
### Mechanical Data

- Case: TO-220, ITO-220, TO-262, TO-263 Package

### Ordering Information

Part No.	Package	Packing
DMT6N65-TU	TO-220	50pcs / Tube
DMF6N65-TU	ITO-220	50pcs / Tube
DMK6N65-TU	TO-262	50pcs / Tube
DMG6N65-TU	TO-263	50pcs / Tube
DMG6N65-TR	TO-263	800pcs / 13" Reel

### Block Diagram



### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	650	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Continuous Drain Current		$I_D$	6.0	A
Pulsed Drain Current (Note 2)		$I_{DM}$	24.8	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	440	mJ
	TO-220/TO-262/TO-263		125	W
Power Dissipation	ITO-220	$P_D$	45	W
Junction Temperature		$T_J$	+150	°C
Operating Temperature		$T_{OPR}$	-55 ~ +150	°C
Storage Temperature		$T_{STG}$	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature

3. L = 24mH,  $I_{AS} = 6A$ ,  $V_{DD} = 90V$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^\circ C$



# 6N65

## 650V N-Channel Power MOSFET

### THERMAL DATA

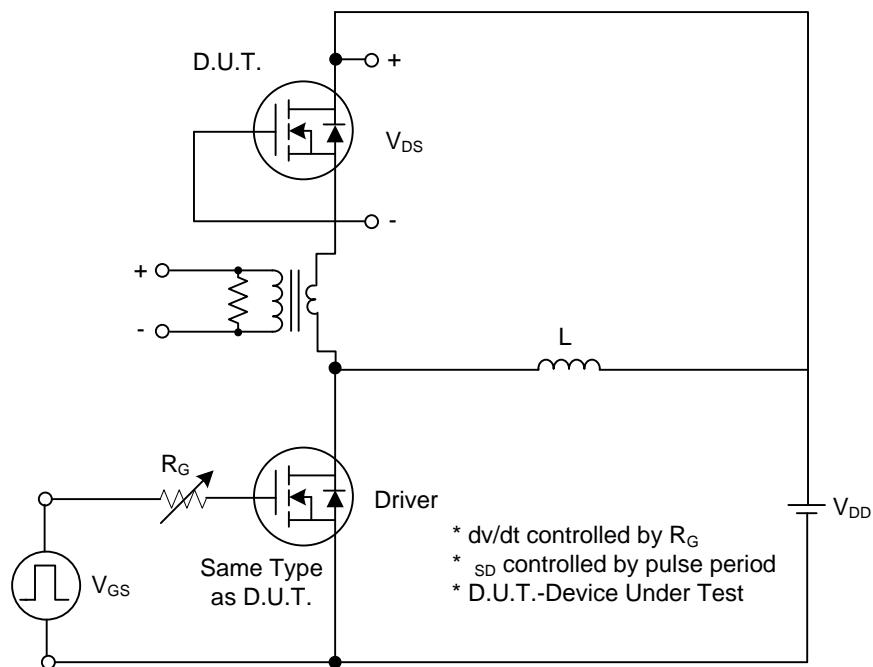
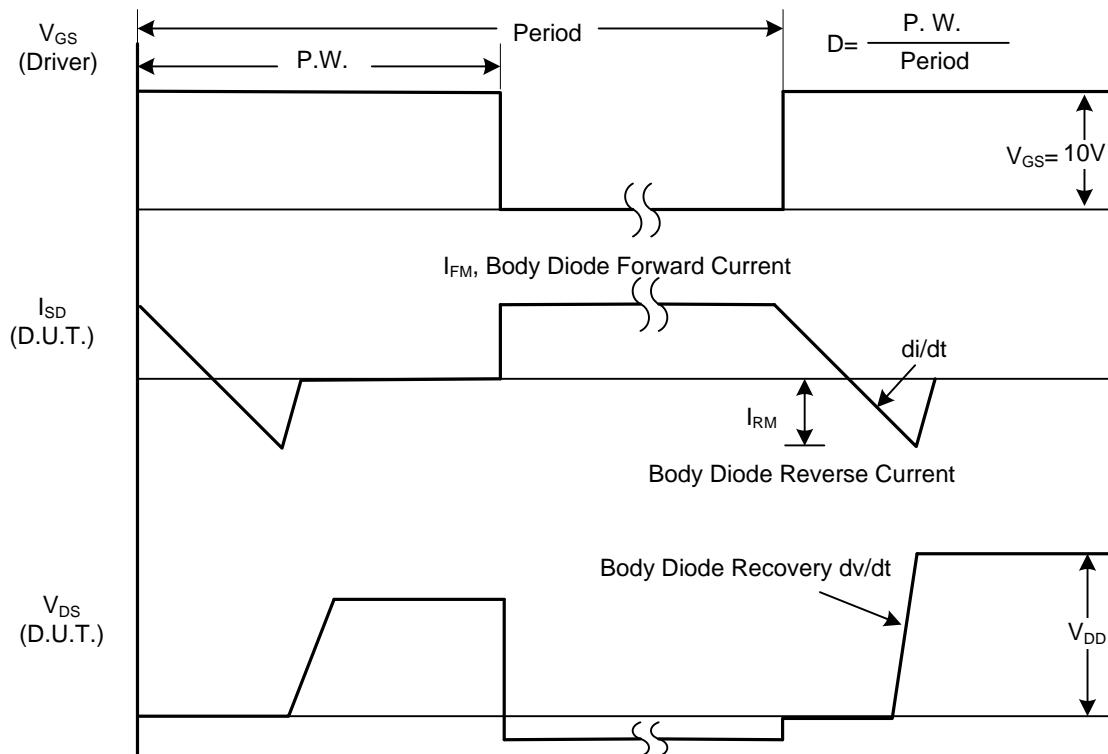
PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/ITO-220 TO-262/TO-263	$\theta_{JA}$	62.5	°C/W
Junction to Case	TO-220 TO-262/TO-263		3.1	
	ITO-220		3.5	

### ELECTRICAL CHARACTERISTICS ( $T_C=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>							
Drain-Source Breakdown Voltage	$\text{BV}_{DSS}$	$V_{GS} = 0\text{V}$ , $I_D = 250\mu\text{A}$	650				V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS} = 650\text{V}$ , $V_{GS} = 0\text{V}$			10		$\mu\text{A}$
Gate-Source Leakage Current	Forward	$I_{GSS}$	$V_{GS} = 30\text{V}$ , $V_{DS} = 0\text{V}$			100	nA
	Reverse		$V_{GS} = -30\text{V}$ , $V_{DS} = 0\text{V}$			-100	nA
<b>ON CHARACTERISTICS</b>							
Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{DS} = V_{GS}$ , $I_D = 250\mu\text{A}$	2.0		4.0		V
Static Drain-Source On-State Resistance	$R_{DS(\text{ON})}$	$V_{GS} = 10\text{V}$ , $I_D = 3.1\text{A}$			1.1	1.7	$\Omega$
<b>DYNAMIC CHARACTERISTICS</b>							
Input Capacitance	$C_{ISS}$	$V_{DS} = 25\text{V}$ , $V_{GS} = 0\text{V}$ , $f = 1\text{MHz}$		950			pF
Output Capacitance	$C_{OSS}$			95			pF
Reverse Transfer Capacitance	$C_{RSS}$			20			pF
<b>SWITCHING CHARACTERISTICS</b>							
Turn-On Delay Time	$t_{D(\text{ON})}$	$V_{DD} = 325\text{V}$ , $I_D = 6.2\text{A}$ , $R_G = 25\Omega$ (Note 1, 2)		45			ns
Turn-On Rise Time	$t_R$			100			ns
Turn-Off Delay Time	$t_{D(\text{OFF})}$			300			ns
Turn-Off Fall Time	$t_F$			220			ns
Total Gate Charge	$Q_G$	$V_{DS} = 520\text{V}$ , $I_D = 6.2\text{A}$ , $V_{GS} = 10\text{V}$ (Note 1, 2)		180			nC
Gate-Source Charge	$Q_{GS}$			8			nC
Gate-Drain Charge	$Q_{GD}$			20			nC
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>							
Drain-Source Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0\text{V}$ , $I_S = 6\text{A}$			1.4		V
Maximum Continuous Drain-Source Diode Forward Current	$I_S$				6.0		A
Maximum Pulsed Drain-Source Diode Forward Current	$I_{SM}$				24.8		A
Reverse Recovery Time	$t_{rr}$	$V_{GS} = 0\text{V}$ , $I_S = 6.2\text{A}$ , $dI_F/dt = 100\text{ A}/\mu\text{s}$ (Note 1)		260			ns
Reverse Recovery Charge	$Q_{RR}$			2.5			$\mu\text{C}$

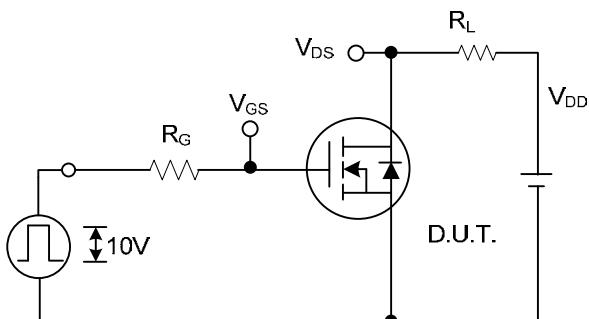
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$

2. Essentially independent of operating temperature

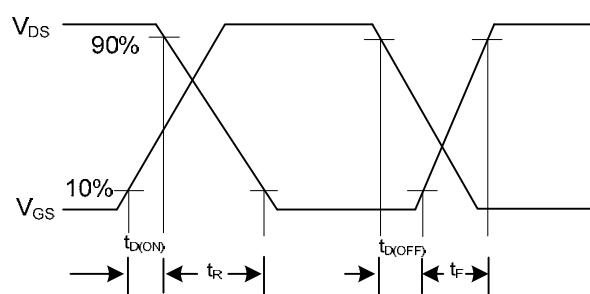
**TEST CIRCUITS AND WAVEFORMS****Peak Diode Recovery dv/dt Test Circuit****Peak Diode Recovery dv/dt Waveforms**



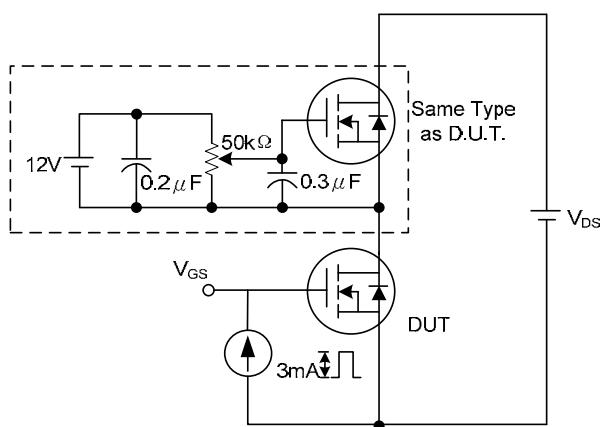
TEST CIRCUITS AND WAVEFORMS(Cont.)



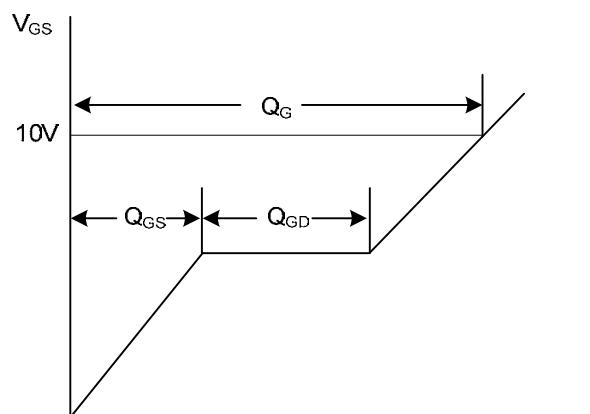
Switching Test Circuit



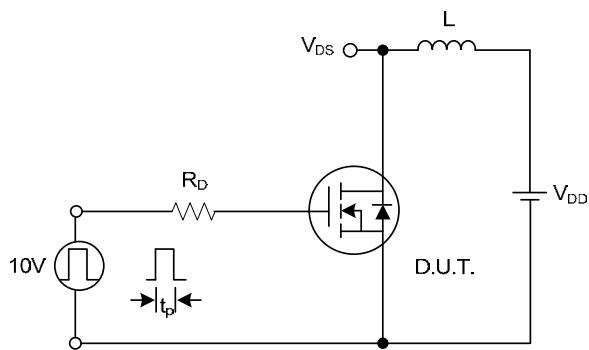
Switching Waveforms



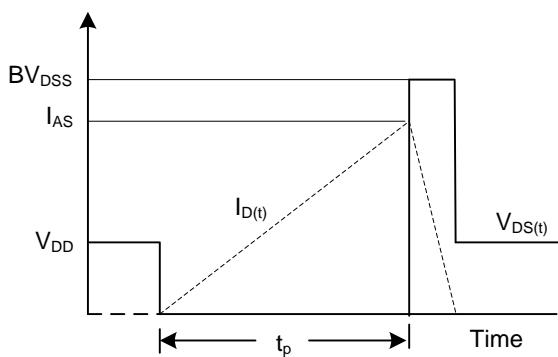
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



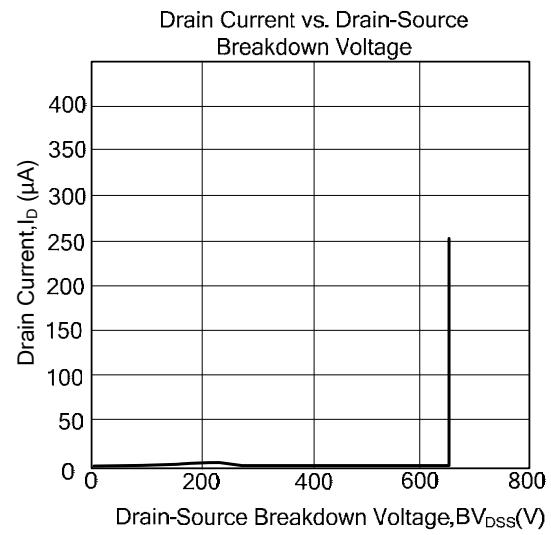
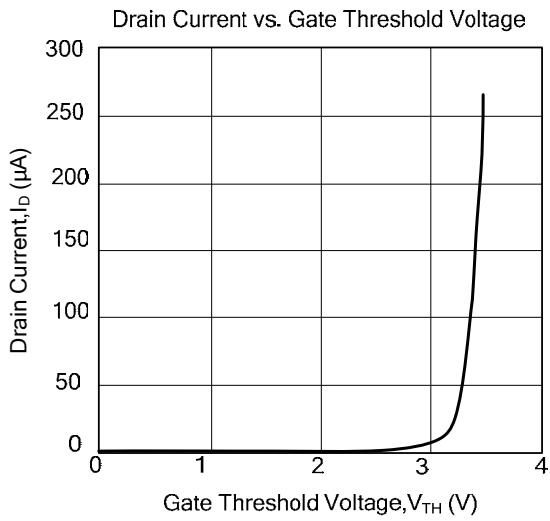
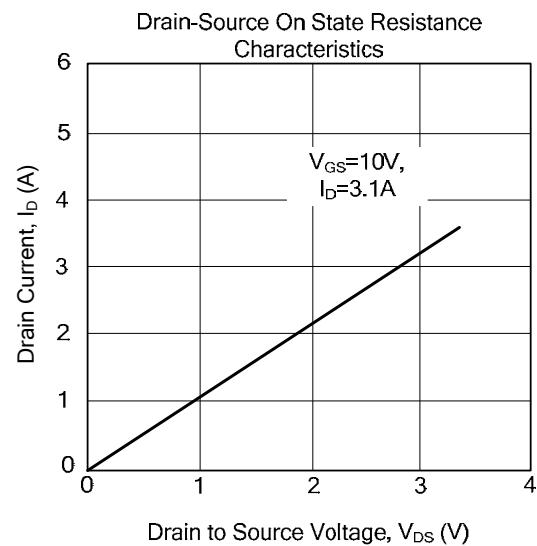
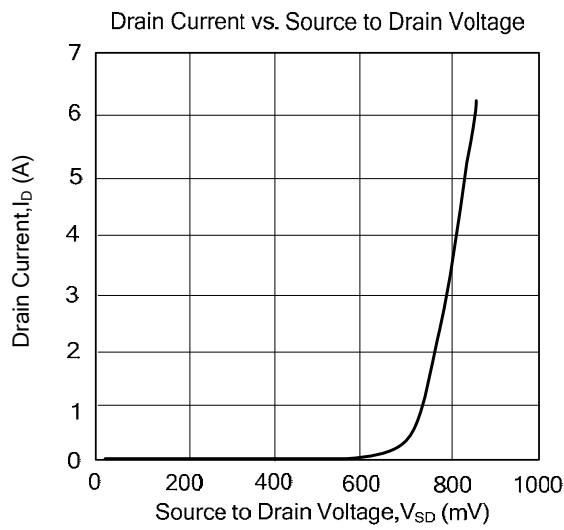
Unclamped Inductive Switching Waveforms



# 6N65

## 650V N-Channel Power MOSFET

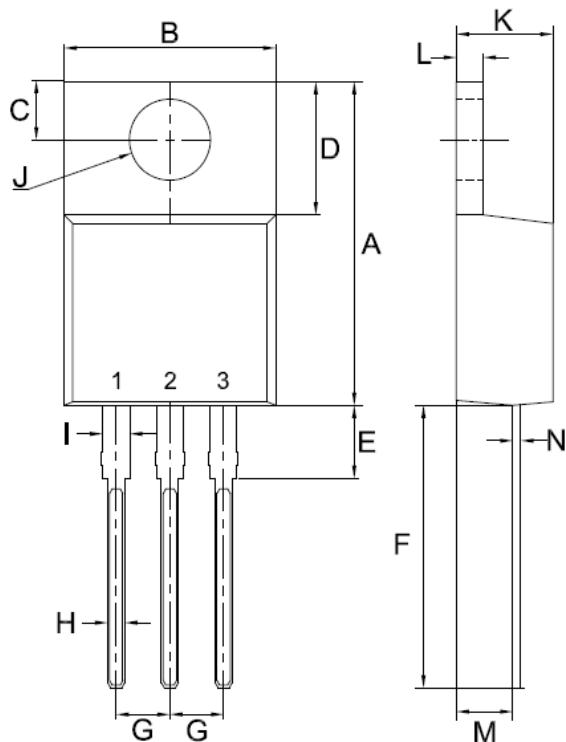
### TYPICAL CHARACTERISTICS



**6N65**

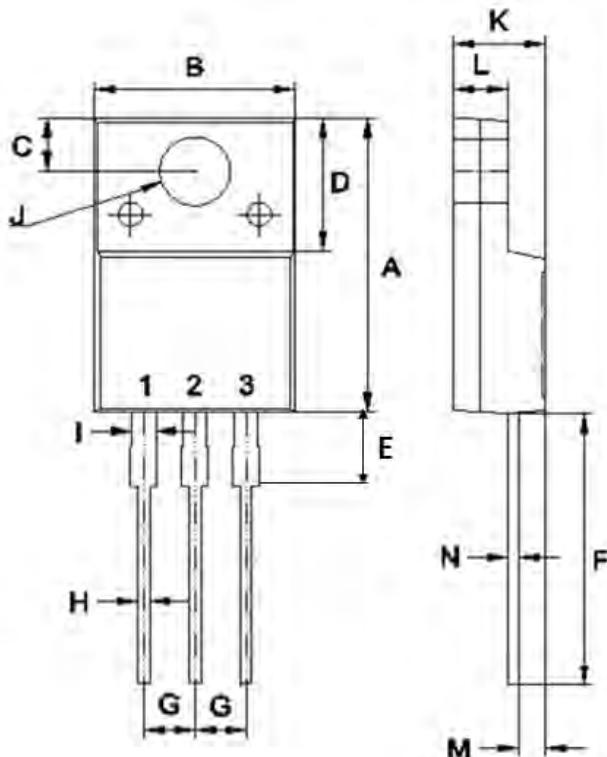
650V N-Channel Power MOSFET

### TO-220 Mechanical Drawing



TO-220AB		
Unit:mm		
DIM	MIN	MAX
A	14.80	15.80
B	9.57	10.57
C	2.54	2.94
D	5.80	6.80
E	2.95	3.95
F	12.70	13.40
G	2.34	2.74
H	0.51	1.11
I	0.97	1.57
J	3.54φ	4.14φ
K	4.27	4.87
L	1.07	1.47
M	2.03	2.92
N	0.30	0.64

### ITO-220 Mechanical Drawing



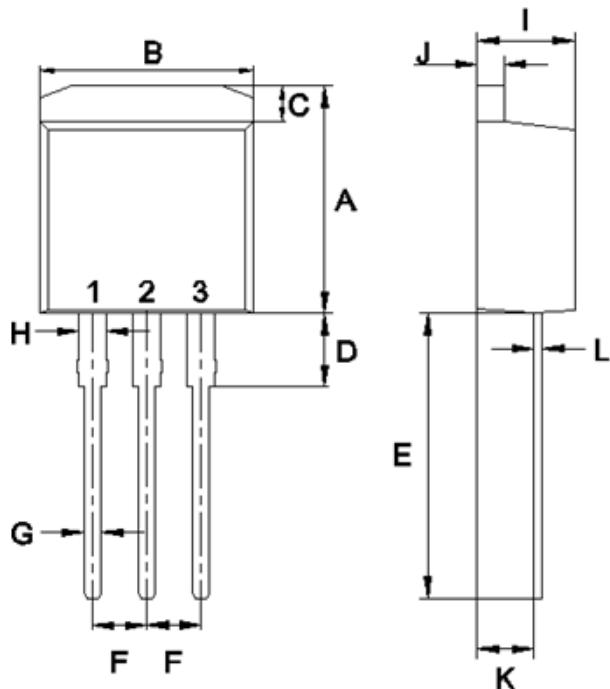
ITO-220AB Unit:mm		
DIM	MIN	MAX
A	14.50	15.50
B	9.50	10.50
C	2.50	2.90
D	6.30	7.30
E	3.30	4.30
F	13.00	14.00
G	2.35	2.75
H	0.30	0.90
I	0.90	1.50
J	3.20	3.80
K	4.24	4.84
L	2.52	2.92
M	1.09	1.49
N	0.47	0.64



6N65

650V N-Channel Power MOSFET

### TO-262 Mechanical Drawing

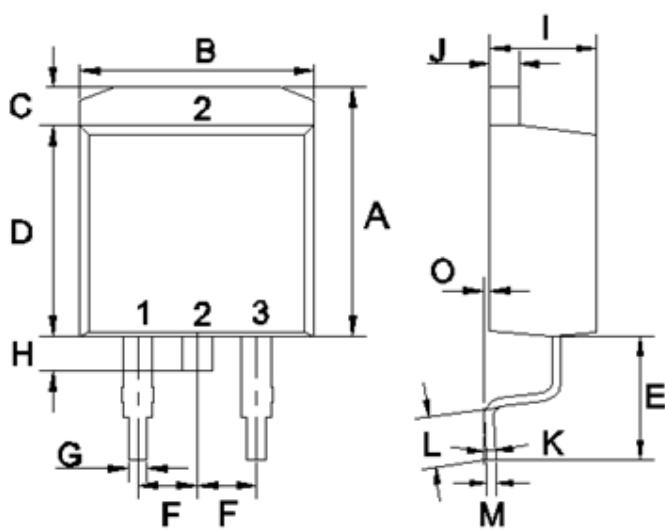


**TO-262(I<sup>2</sup>PAK)**

Unit:mm

DIM	MIN	MAX
A	10.14	11.14
B	9.57	10.57
C	1.44	1.84
D	2.95	3.95
E	12.70	13.40
F	2.34	2.74
G	0.51	1.11
H	0.97	1.57
I	4.27	4.87
J	1.07	1.47
K	2.03	2.92
L	0.30	0.46

### TO-263 Mechanical Drawing



**TO-263 (D<sup>2</sup> PAK)**

Unit:mm

DIM	MIN	MAX
A	10.44	10.84
B	9.81	10.21
C	1.44	1.84
D	8.80	9.20
E	4.46	4.66
F	2.44	2.64
G	0.61	1.01
H	0.70	1.30
I	4.27	4.87
J	1.07	1.47
K	0°	8°
L	2.10	2.50
M	0.30	0.46
O	0	0.25